

### **MBR0540**

### **Features**

- 0.5 ampere; forward voltage less than 460 mv.
- 400 milliwatt Power Dissipation package.
- Compact surface mount package with same footprint as mini-melf.



SOD123 Color Band Denotes Cathode Mark: B4

## **Schottky Rectifiers**

**Absolute Maximum Ratings\*** T<sub>A</sub> = 25°C unless otherwise noted

Symbol	Parameter	Value	Units
$V_{RRM}$	Maximum Repetitive Reverse Voltage	40	V
I <sub>F(AV)</sub>	Average Rectified Forward Current	500	mA
I <sub>FSM</sub>	Non-repetitive Peak Forward Surge Current half wave, single phase, 60 Hz	5.5	А
T <sub>stg</sub>	Storage Temperature Range	-65 to +150	°C
T <sub>J</sub>	Operating Junction Temperature	-65 to +125	°C

 $<sup>{}^{\</sup>textstyle \star} \text{These ratings are limiting values above which the serviceability of any semiconductor device may be impaired.}$ 

### **Thermal Characteristics**

Symbol	Parameter	Value	Units
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient *	206	°C/W
R <sub>eJL</sub>	Thermal Resistance, Junction to Lead **	118	°C/W

 $<sup>^{*}</sup>$ 1.0 inch" pad size (1.0 x 0.5 inch for each lead) on FR4 board.

### Electrical Characteristics T<sub>A</sub> = 25°C unless otherwise noted

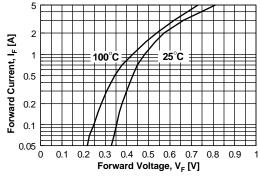
Symbol	Parameter		Value	Units
$V_{F}$	Forward Voltage	@ $I_F = 500 \text{ mA}$ ,	510	mV
		$I_F = 500 \text{ mA}, T_A = 100^{\circ}\text{C}$ $I_F = 1.0 \text{ A},$	460 620	mV mV
		$I_F = 1.0 \text{ A}, T_A = 100^{\circ}\text{C}$	610	mV
I <sub>R</sub>	Reverse Current	$@V_R = 20 V,$	10	μA
		$V_{R} = 20 \text{ V}, T_{A} = 100^{\circ}\text{C}$	5.0	mA
		$V_R = 40 \text{ V},$	20	μA
		$V_R = 40 \text{ V}, T_A = 100^{\circ}\text{C}$	13	mA

<sup>\*\*</sup>Device mounted on FR-4 PCB 0.013 mm.

# **Schottky Rectifier**

(continued)

## **Typical Characteristics**



**Figure 1. Forward Voltage Characteristics** 

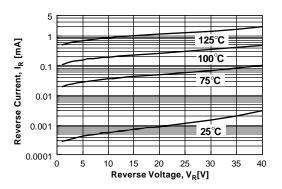


Figure 2. Reverse Current vs Reverse Voltage

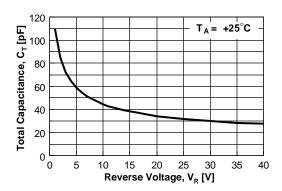


Figure 3. Total Capacitance

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